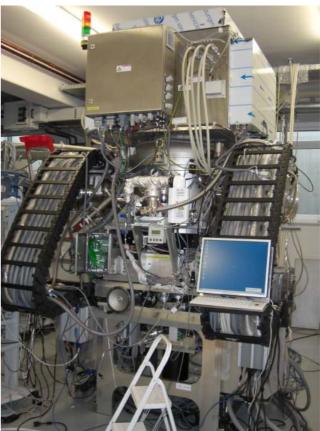
# Progress on DPP source development towards HVM

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2007 International Symposium on Extreme Ultraviolet Lithography 29-31 October 2007 Sapporo, Japan





XTS 13-150 IF

## Outline

- 1. Progress on commercial Xe sources
- 2. HVM source development and Roadmap
- 3. Summary





# **XTREME leads installed EUV sources in the field**

- 6 DPP sources in use for wafer exposures
- 10 DPP sources operated for EUV research
- XTS13-150 IF has been successfully integrated at customer side



XTS13-35





XTS13-150IF

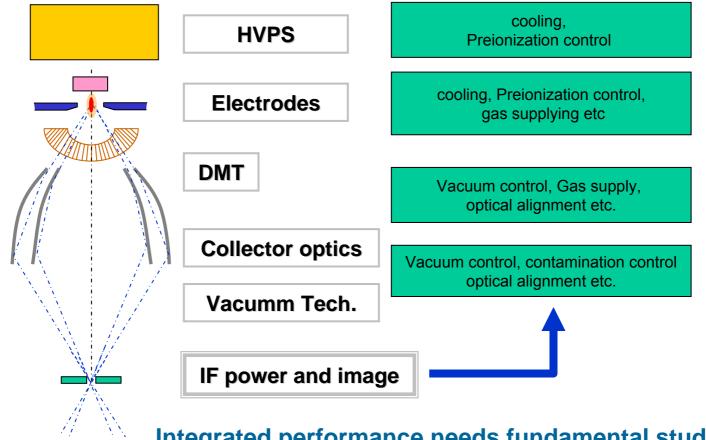
 Integrated metrology tools provide for reliable operation with constant source characteristics

**XTS13-75IF** 

 Performance results and improvements benefit from partnering with key component suppliers and feedback received from customers

## **DPP source is an integration of crucial key components**

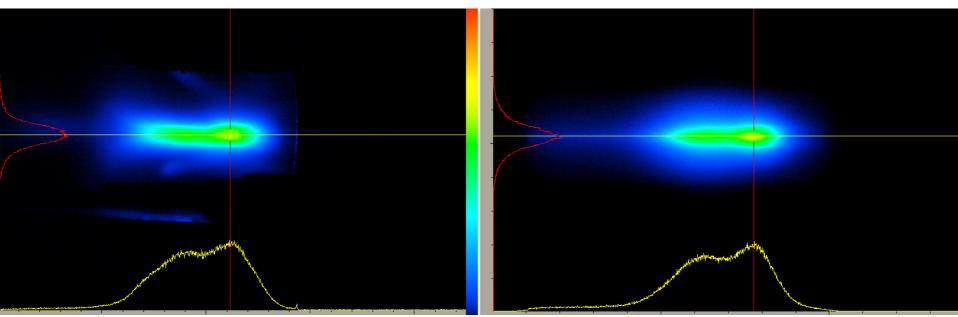
#### **XTREME** has provided integrated performance of SoCoMo



Integrated performance needs fundamental study and feedback received from customers

## **Source Model Enables Reliable Ray Tracing Simulations**

#### Key objective: model to reproduce spatial plasma power distribution



Pinch, measured

Pinch, ZEMAX<sup>®</sup> model

(identical scale & total power)

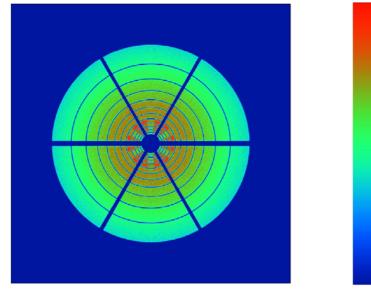
**Optical source model permits reliable calculations:** 

- Collection efficiency reproduced within 10%
  - SoCoMo Far Field simulations

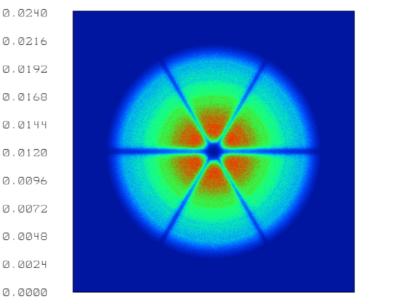
## **SoCoMo** Ray Tracing Allows Far Field Predictions

Effect of extended source vs. point like source:

- Collector efficiency drop  $15.9\% \rightarrow 8.8\%$
- DMT transmission drop 87.8% →83.2% Extended source prediction confirmed by measurements







#### Extended source



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0.0147

0.0133

0.0118

0.0103

0.0088

0.0074

0.0059

0.0044

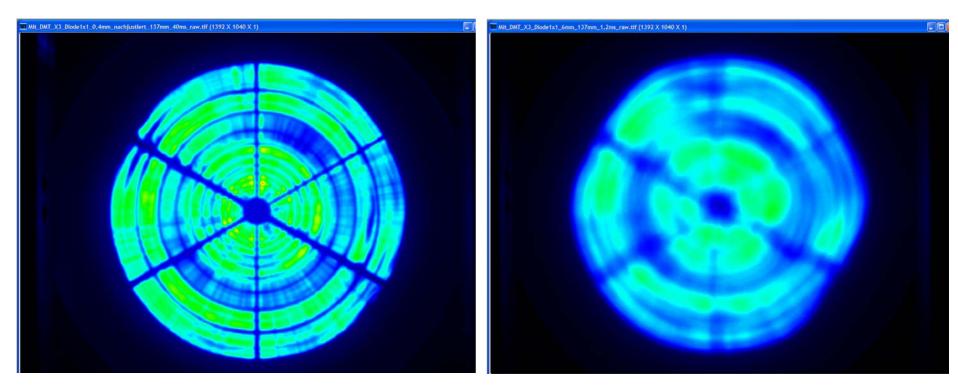
0.0029

0.0015

0.0000

#### **VIS Test Stand Strongly Supports Optical Performance Optimization**

- Measurements with different source geometry
- Characterization of individual and convoluted contributions of collector and DMT to far field uniformity
- Efficiently used for optimization of far field imaging performance

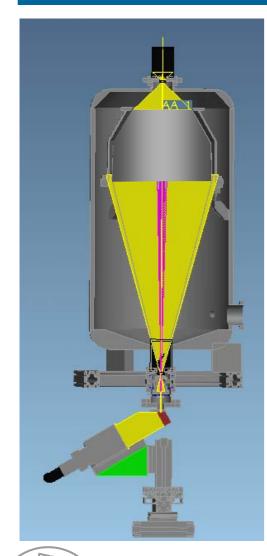




#### Extended pinch like source

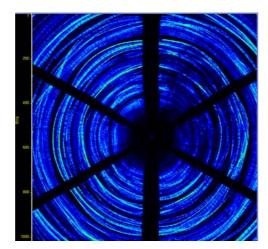
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## **Successful Introduction of New Basic EUV Metrology**



#### **EUV-reflectometer realized by LZH**

- Full collector acceptance
- Collector reflectivity accuracy < 2 %
- Collector/DMT characterization capability
- Keying XTS 13-150 SoCoMo optical performance



Intensity distribution of full collector behind source point



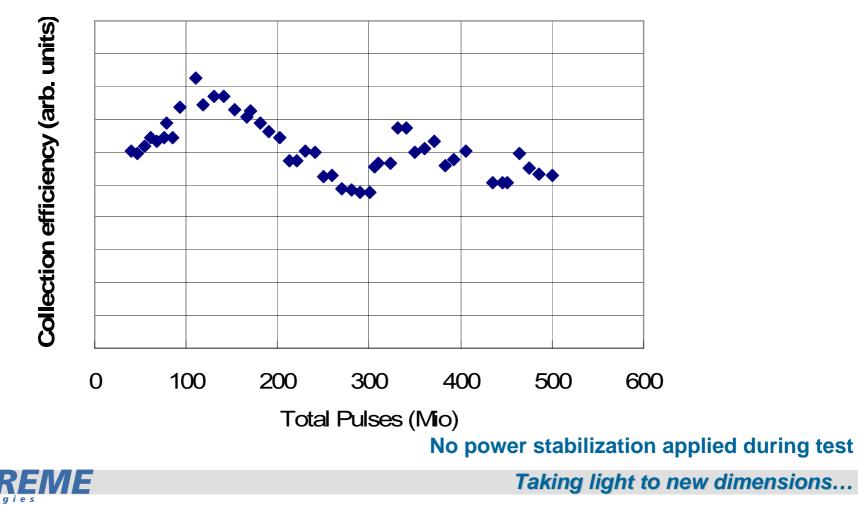
SO-05: U. Hintze et.al., EUV Source Collectors: Characterization of Performance and Lifetime using a Full Size EUV Collector Reflectometer



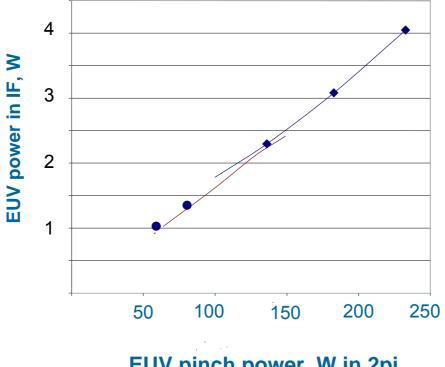


## **Electrode Lifetime Extension Improves Downtime and CoO**

- Electrode lifetime extension achieved by design improvements
- Cathode lifetime 500M and anode lifetime >4B demonstrated
- CE fluctuations can be compensated by energy control



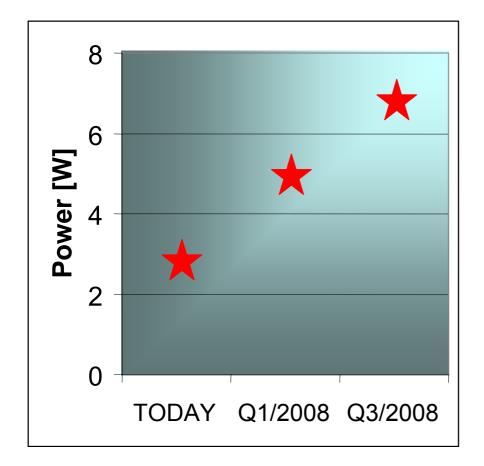
## XTS 13-150 IF: EUV Power @IF vs. source power



- EUV pinch power, W in 2pi
- These are real IF powers, which have been measured and NOT scaled!
- Up to 4W achieved in 100% duty cycle operation
- Collection efficiency almost independent on source parameters (e.g. repetition rate, buffer gas flow)



#### **XTS 13-150 IF Power Status and Roadmap**



- Current Output power @ IF (3 W level) is limited by component lifetime considerations
- Experimental results on improved components evidence output power capability of 7W @IF
- Output power improvement to 4-5W expected in December 2007
- TW evidence until Q2/2008



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## Outline

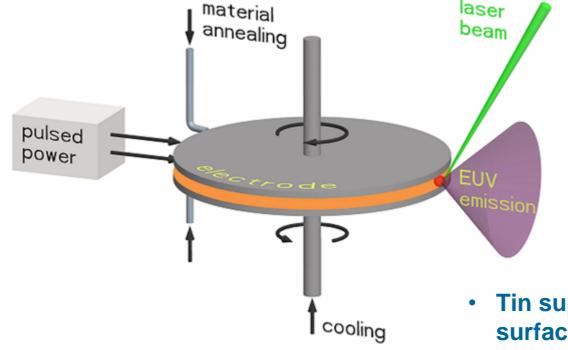
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## **XTREME Develops LA RDE as Promising Technology**

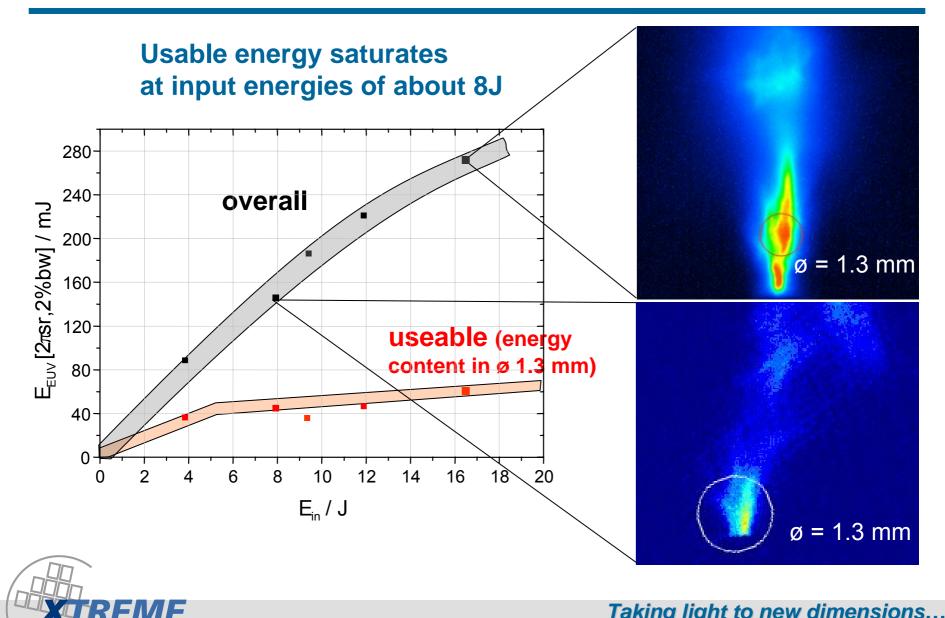
#### Laser Assisted DPP source with Rotating Disk Electrodes (RDE)



- Tin supply regenerates electrode surface and serves as fuel
- increases effective electrode area
- reduces heat load per area
- increases electrode lifetime

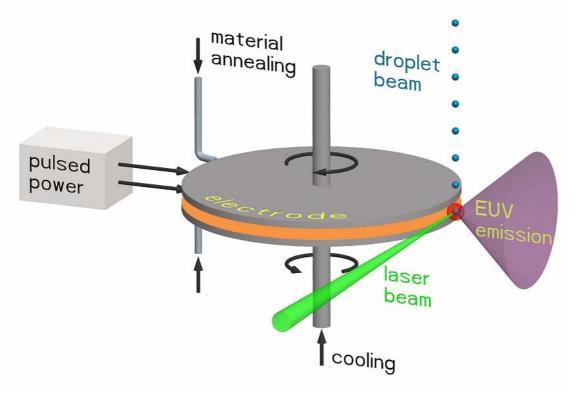


## LA RDE Exhibits Scaling Issues with surface evaporation





## Adding Tin Droplet to LA RDE Solves Saturation Issue



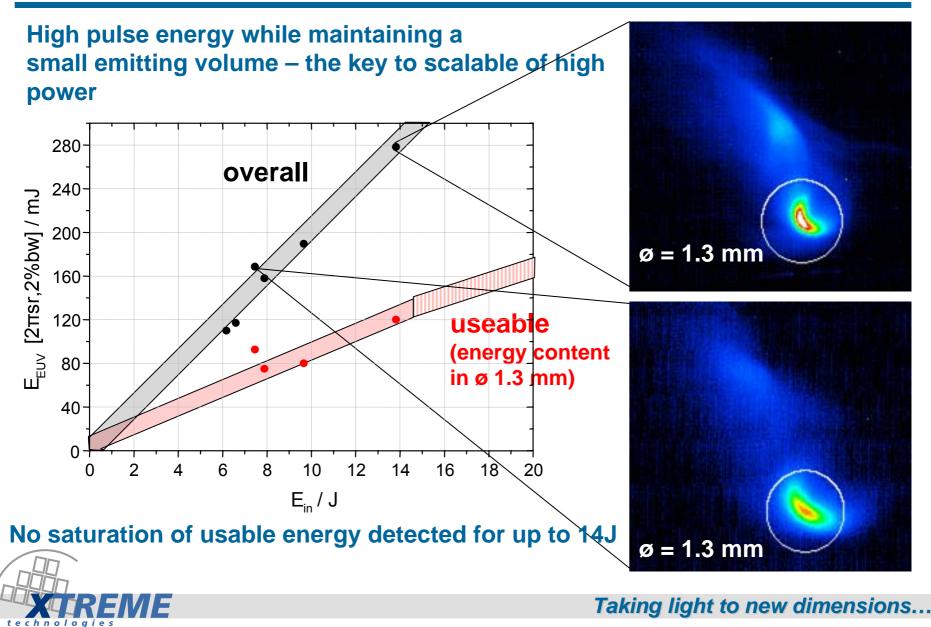
#### Laser assisted droplet RDE design provides;

- higher brightness plasma
  - mass limited tin fuel
    supply
    independent of electrode
    material and electrode
    surface regeneration
- superior scaling possibilities
- large collecting angles feasible

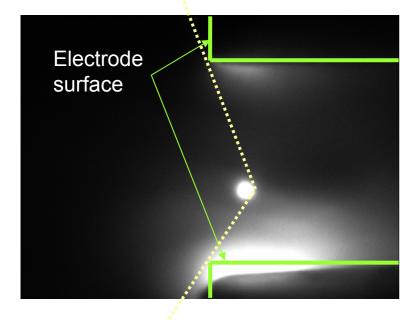
#### **Droplet Technology brings Advantage over Surface Evaporation**

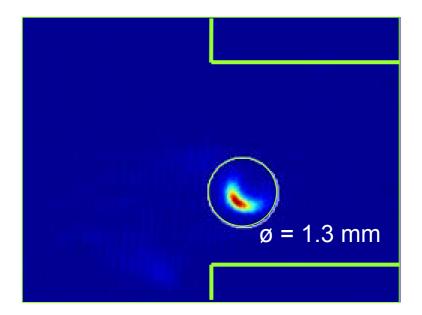


## LA Droplet RDE Source provides High Power for HVM



## LA Droplet RDE Source allows for Large Collection Angle





Visible image of the plasma showing a potentially large opening angle of the electrode arrangement

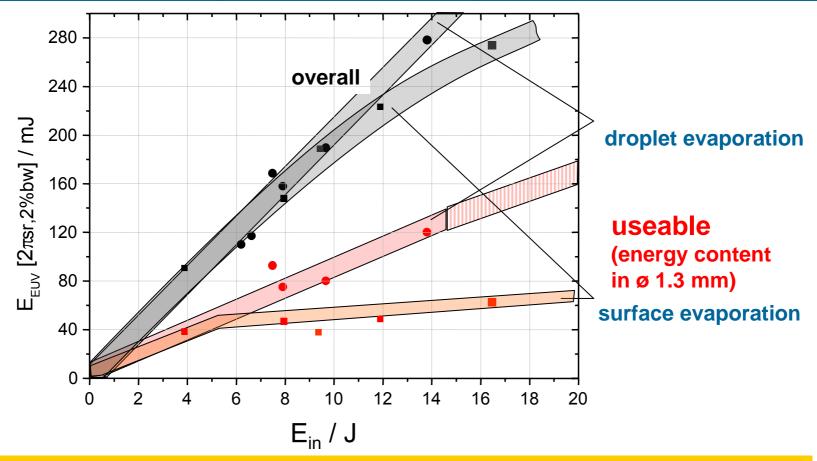
#### **EUV in-band picture of the same pulse**



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## **Comparison between**

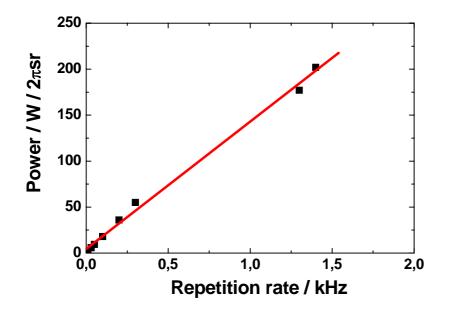
#### surface evaporation and droplet injection



LA RDE with Tin Droplets makes available LPP scaling advantages on robust and proven DPP Technology



# **Outlook and EUV power demonstration**



Output power: 200 W/  $2\pi$  sr at 1.4 kHz Constant conversion efficiency

by end of December 2007

/ | =

Experimental result strongly support scalability.

600W in source power @5kHz will be demonstrated

**Experimental installation** 

# **Key components development for HVM DPP**

- Droplet system is fundamentally established and continuously improved for practical use
- Adding new functions onto similar DMT concept
  of Xe DPP source
- Scaling for higher power metrology tools





	Currently Status 10/2007	1st generation HVM	2nd generation HVM	3rd generation HVM
Electrical input energy into plasma (J)	10	10	15	20
Repetition frequency (kHz)	1.5	7	10	10
Intermediate focus power (W)	<b>6.4</b> <sup>(1)</sup>	62.5	178.5	238

(1) calculated for existing collector mirror



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# **Summary**

#### **Commercial Xe sources**

- Output power @ IF currently 3 W level
- Improvement to 7 W level ongoing according to our roadmap

#### HVM source development

- The new concept of laser assisted droplet RDE source has demonstrated its intrinsic performance
- Thermal management of RDE combined with droplet target supply strognly supports the path to HVM
- Demonstration of 600 W power in  $2\pi$  sr by end of 2007 will enable XTREME technologies to commit for a Beta Level SoCoMo with 50 W IF power in 2008 according to our HVM power roadmap

## **DPP source provides a cost effective solution for HVM!**



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  - JENOPTIK, Jena, Germany
  - USHIO, Tokyo, Japan

